



# Vincotech

<b>flowPFC 0</b>		<b>600 V / 99 mΩ</b>
<b>Features</b>		<b>flow 0 17 mm housing</b>
<ul style="list-style-type: none"><li>• Compact and low inductance design</li><li>• Suitable for Interleaved topology</li><li>• Suitable for current sensing in source</li><li>• C6 series CoolMos™ and SiC boost diode</li></ul>		
<b>Target applications</b>		<b>Schematic</b>
<ul style="list-style-type: none"><li>• Power Supply</li><li>• Welding &amp; Cutting</li></ul>		
<b>Types</b>		
<ul style="list-style-type: none"><li>• 10-FX062TA099FS-P980D57</li></ul>		



10-FX062TA099FS-P980D57

datasheet

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## Maximum Ratings

$T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>PFC Switch</b>				
Drain-source voltage	$V_{DSS}$		600	V
Drain current (DC current)	$I_D$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	19	A
Peak drain current	$I_{DM}$	$t_p$ limited by $T_{jmax}$	112	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	88	W
Gate-source voltage	$V_{GSS}$		$\pm 20$	V
Maximum Junction Temperature	$T_{jmax}$		150	$^\circ\text{C}$

## PFC Diode

Peak repetitive reverse voltage	$V_{RRM}$		600	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	15	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	46	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10 \text{ ms}$ $T_j = 25^\circ\text{C}$	90	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	35	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Rectifier Thyristor

Repetitive peak reverse voltage	$V_{RRM}$		1200	V
Maximum RMS on-state current	$I_{TRMSM}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	26	A
Surge on-state current	$I_{TSM}$	Single Half Sine Wave, $t_p = 10 \text{ ms}$ $T_j = 125^\circ\text{C}$	320	A
$I^2t$ value	$I^2t$	Single Half Sine Wave, $t_p = 8,3 \text{ ms}$ $T_j = 125^\circ\text{C}$	510	$\text{A}^2\text{s}$
Mean total power loss	$P_{tot(AV)}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	60	W
Maximum Junction Temperature	$T_{jmax}$		150	$^\circ\text{C}$



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## Maximum Ratings

$T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Rectifier Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		1600	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$	47	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10 \text{ ms}$	280	A
Surge current capability	$I_t$	$T_j = 150^\circ\text{C}$	390	$\text{A}^2\text{s}$
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$	59	W
Maximum junction temperature	$T_{jmax}$		150	$^\circ\text{C}$

## PFC Shunt

DC current	$I$	$T_c = 70^\circ\text{C}$	26	A
Power dissipation	$P_{tot}$	$T_c = 70^\circ\text{C}$	7	W

## Capacitor (DC)

Maximum DC voltage	$V_{MAX}$		500	V
Operation Temperature	$T_{op}$		-55 ... 125	$^\circ\text{C}$

## Module Properties

Thermal Properties				
Storage temperature	$T_{stg}$		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	$T_{jop}$		-40...+( $T_{jmax} - 25$ )	$^\circ\text{C}$

## Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage*	$t_p = 2 \text{ s}$	4000	V
Isolation voltage	$V_{isol}$	AC Voltage	$t_p = 1 \text{ min}$	2500	V
Creepage distance				>12,7	mm
Clearance				>12,7	mm
Comparative Tracking Index	CTI			$\geq 200$	

\*100 % tested in production



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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	

### PFC Switch

#### Static

Drain-source on-state resistance	$r_{DS(on)}$		10		18,1	25 125		99 199	99 <sup>(1)</sup>	mΩ
Gate-source threshold voltage	$V_{GS(th)}$		0		0,00121	25	2,4	3	3,6	V
Gate to Source Leakage Current	$I_{GSS}$		20	0		25			100	nA
Zero Gate Voltage Drain Current	$I_{DSS}$		0	600		25			5	μA
Internal gate resistance	$r_g$							1,6		Ω
Gate charge	$Q_g$	$V_{DD} = 480$ V	0/10		18,1	25		119		nC
Short-circuit input capacitance	$C_{iss}$	$f = 1$ Mhz	0	100	0	25		2660		pF
Short-circuit output capacitance	$C_{oss}$							154		
Diode forward voltage	$V_{SD}$		0		18,1	25		0,9		V

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,8		K/W
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#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 2 \Omega$ $R_{goff} = 2 \Omega$	0/10	400	18	25 125		19,8 19,4		ns
Rise time	$t_r$					25 125		3,6 3,8		ns
Turn-off delay time	$t_{d(off)}$					25 125		90,2 92,4		ns
Fall time	$t_f$					25 125		3,07 3,58		ns
Turn-on energy (per pulse)	$E_{on}$					25 125		0,053 0,063		mWs
Turn-off energy (per pulse)	$E_{off}$					25 125		0,015 0,023		mWs



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### PFC Diode

#### Static

Forward voltage	$V_F$				10	25 125 150		1,49 1,69 1,78	1,8 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 600$ V				25 150		10 20	50 200	µA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						2,75		K/W
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#### Dynamic

Peak recovery current	$I_{RRM}$	$di/dt=5949$ A/µs $di/dt=4798$ A/µs	0/10	400	18	25 125		18,12 15,58		A
Reverse recovery time	$t_{rr}$					25 125		6,94 7,44		ns
Recovered charge	$Q_r$					25 125		0,06 0,051		µC
Reverse recovered energy	$E_{rec}$					25 125		$2,7 \times 10^{-3}$ $1,535 \times 10^{-3}$		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125		8682 5922		A/µs



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### Rectifier Thyristor

#### Static

On-state voltage	$V_T$				44	25 125		1,39 1,41	1,33 1,32		V
On-state threshold voltage	$V_{T(TO)}$				44	125			0,9		V
On-state slope resistance	$r_T$				44	125			9		mΩ
Direct reverse current	$I_{RD}$	$V_i = 1200$ V				25 125			10 2		μA
Holding current	$I_H$			6		25			50		mA
Latching current	$I_L$	$t_p = 10 \mu s$ $I_G = 0,2$ A $dI_G/dt = A/\mu s$				25			90		mA
Gate trigger voltage	$V_{GT}$			6		25			1,3		V
Gate trigger current	$I_{GT}$			6		25	11		28		mA
Gate non-trigger voltage	$V_{GD}$			2/3 $V_{DRM}$		125			0,2		V
Gate non-trigger current	$I_{GD}$					25			1		mA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,16		K/W
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### Rectifier Diode

#### Static

Forward voltage	$V_F$				50	25 125		1,24 1,24	1,3 <sup>(1)</sup> 1,33 <sup>(1)</sup>		V
Reverse leakage current	$I_R$	$V_i = 1600$ V				25 150			20 1500		μA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,2		K/W
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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max

### PFC Shunt

#### Static

Resistance	$R$							10		$\text{m}\Omega$
Tolerance							-1		1	%
Temperature coefficient	$tc$						50			$\text{ppm/K}$

### Capacitor (DC)

#### Static

Capacitance	$C$	DC bias voltage = 0 V				25		270		$\text{nF}$
Tolerance						-20		20		%

### Thermistor

#### Static

Rated resistance	$R$				25		22			$\text{k}\Omega$
Deviation of $R_{100}$	$A_{R/R}$	$R_{100} = 1484 \Omega$			100	-5		5		%
Power dissipation	$P$						5			$\text{mW}$
Power dissipation constant	$d$				25		1,5			$\text{mW/K}$
B-value	$B_{(25/50)}$	Tol. $\pm 1\%$					3962			K
B-value	$B_{(25/100)}$	Tol. $\pm 1\%$					4000			K
Vincotech Thermistor Reference									I	

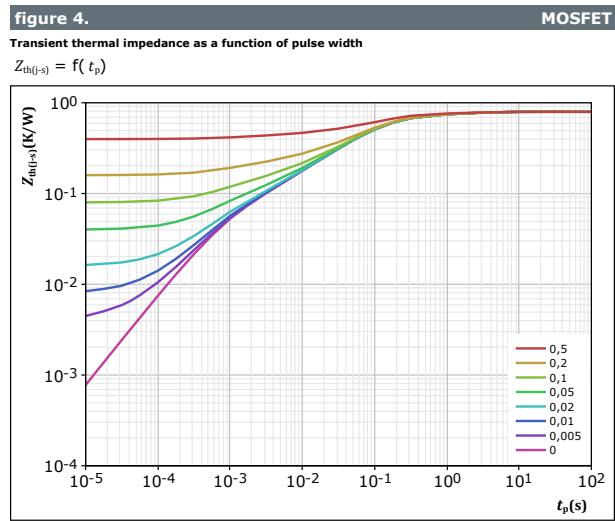
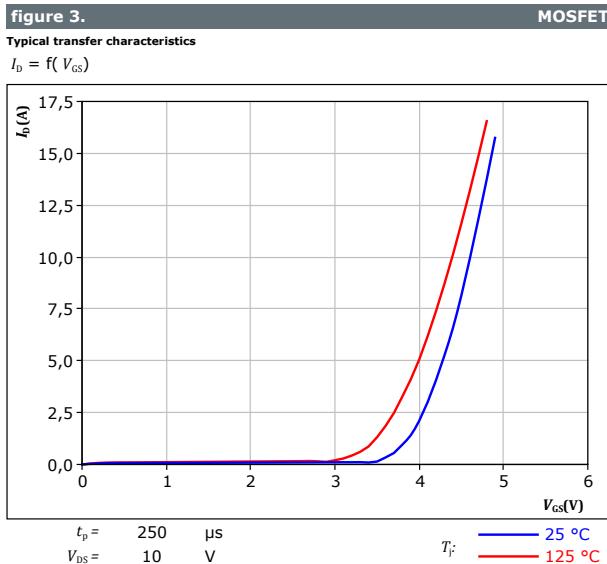
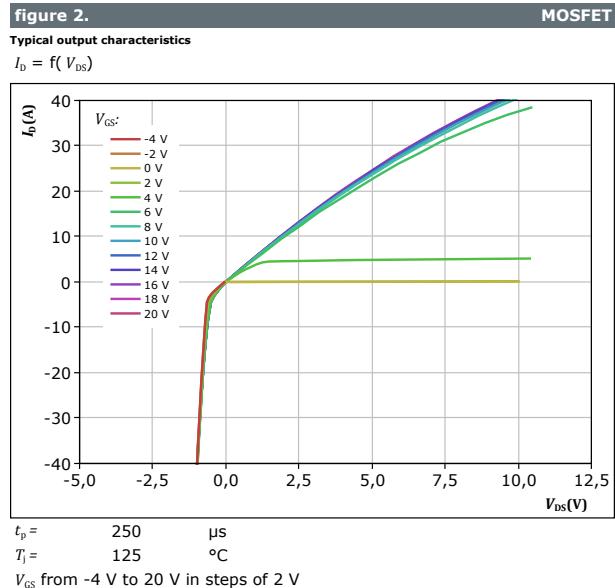
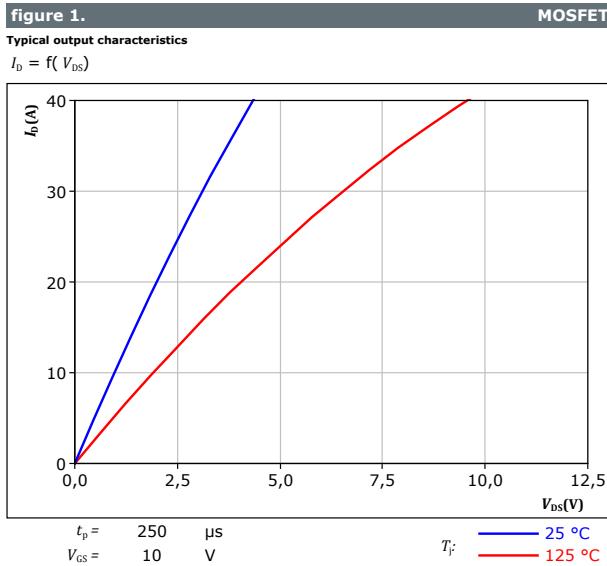
(1) Value at chip level

(2) Only valid with pre-applied Vincotech thermal interface material.



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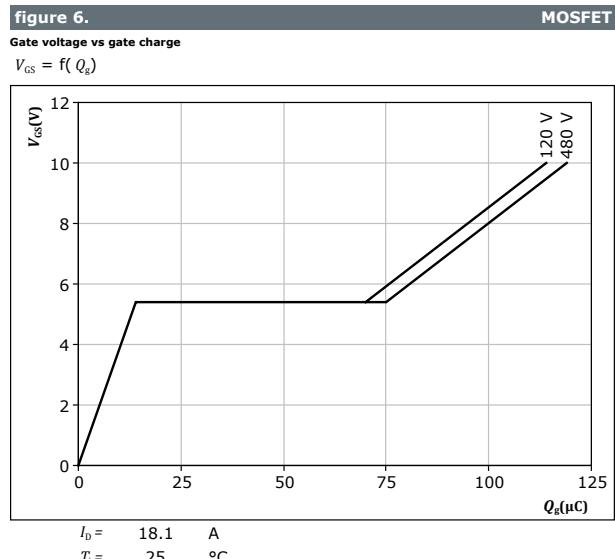
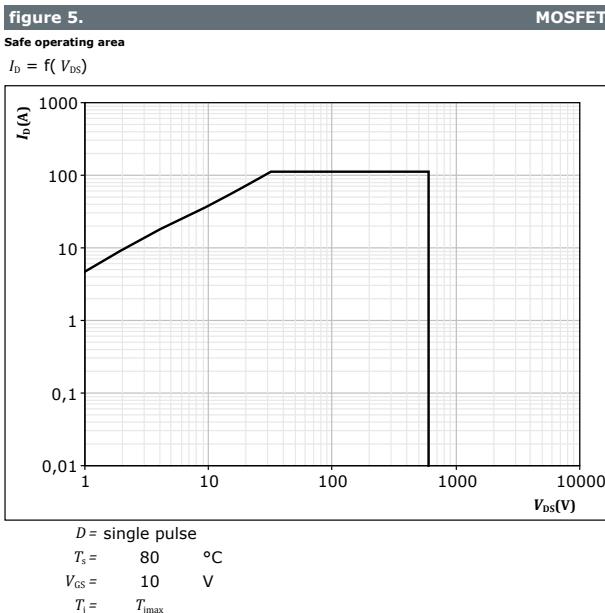
## PFC Switch Characteristics





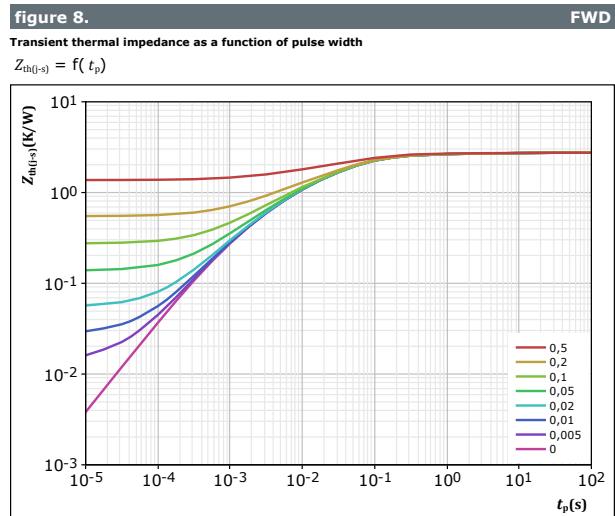
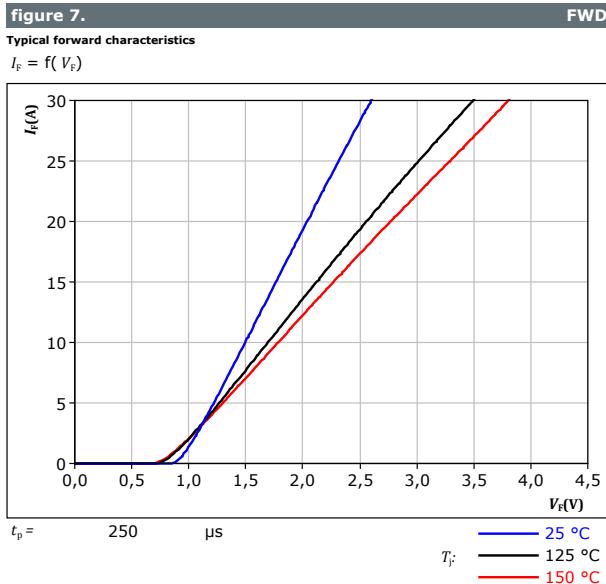
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## PFC Switch Characteristics



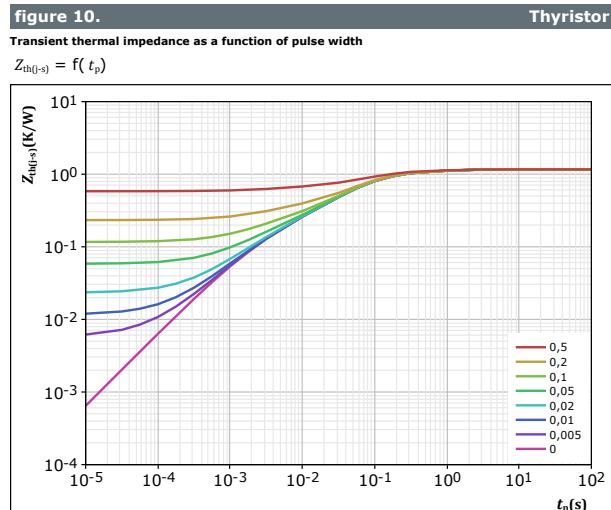
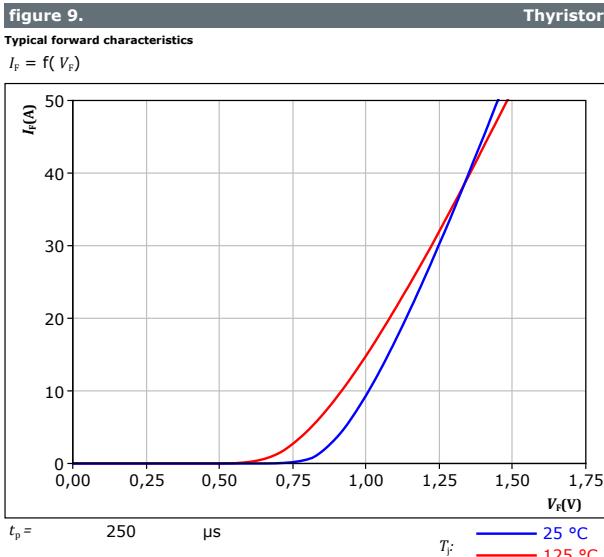


## PFC Diode Characteristics





## Rectifier Thyristor Characteristics



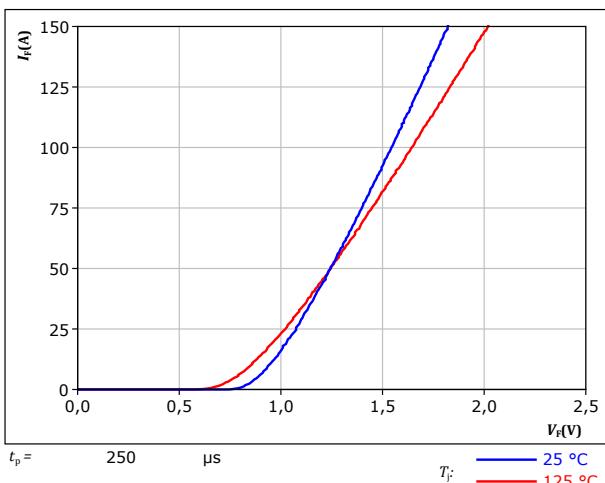


## Rectifier Diode Characteristics

figure 11.

Typical forward characteristics

$$I_F = f(V_F)$$

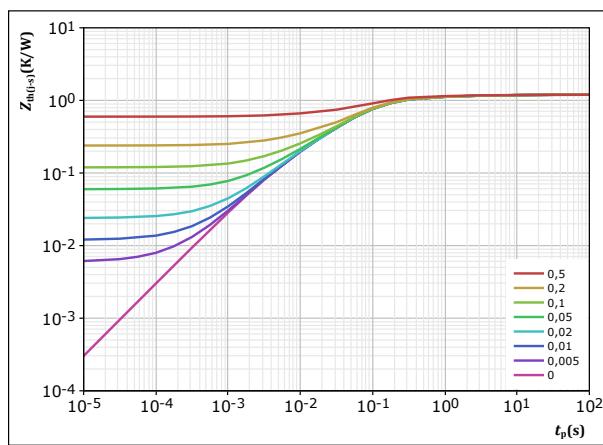


Rectifier

figure 12.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



Rectifier

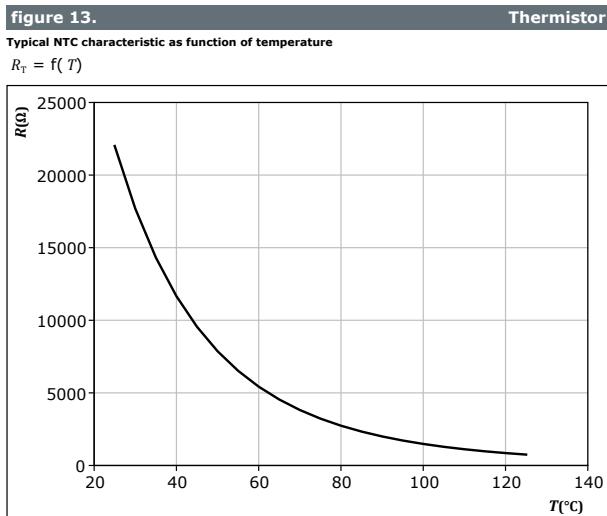
$$D = \frac{t_p / T}{R_{th(j-s)}} = \frac{1,195}{1,195} \text{ K/W}$$

Rectifier thermal model values

$R$ (K/W)	$\tau$ (s)
4,87E-02	6,80E+00
1,57E-01	6,29E-01
7,33E-01	9,05E-02
1,69E-01	3,10E-02
7,37E-02	4,76E-03
1,39E-02	1,53E-02



## Thermistor Characteristics



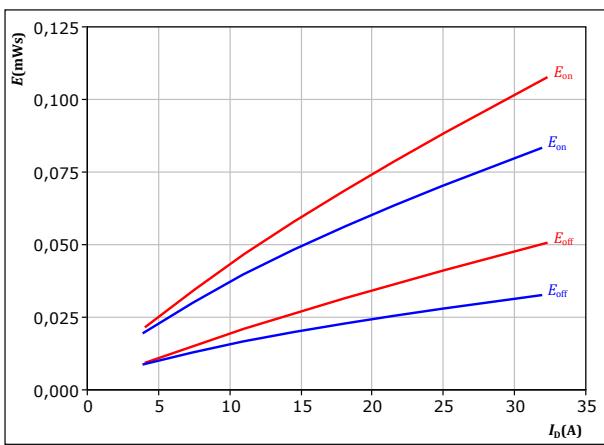


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## PFC Switching Characteristics

figure 14.

Typical switching energy losses as a function of drain current  
 $E = f(I_D)$



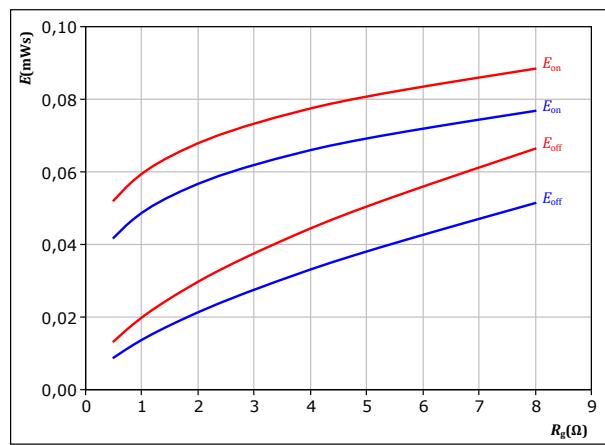
With an inductive load at

$V_{DS} = 400$  V  
 $V_{GS} = 0/10$  V  
 $R_{gon} = 2$  Ω  
 $R_{goff} = 2$  Ω

MOSFET

figure 15.

Typical switching energy losses as a function of gate resistor  
 $E = f(R_g)$



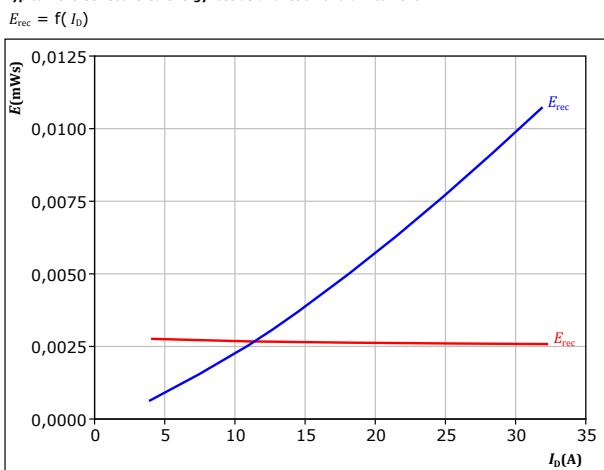
With an inductive load at

$V_{DS} = 400$  V  
 $V_{GS} = 0/10$  V  
 $I_D = 18$  A

MOSFET

figure 16.

Typical reverse recovered energy loss as a function of drain current  
 $E_{rec} = f(I_D)$



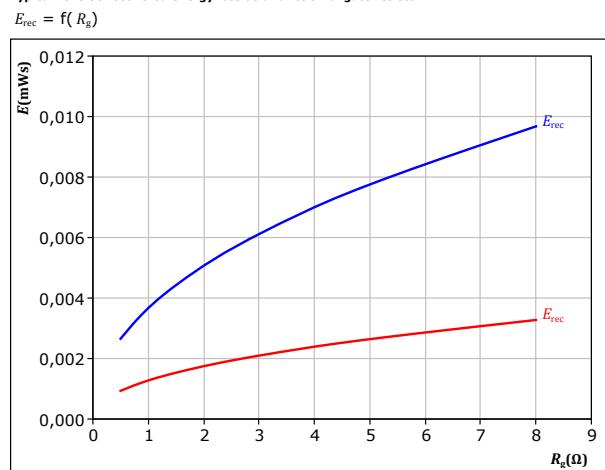
With an inductive load at

$V_{DS} = 400$  V  
 $V_{GS} = 0/10$  V  
 $R_{gon} = 2$  Ω

FWD

figure 17.

Typical reverse recovered energy loss as a function of gate resistor  
 $E_{rec} = f(R_g)$



With an inductive load at

$V_{DS} = 400$  V  
 $V_{GS} = 0/10$  V  
 $I_D = 18$  A

FWD

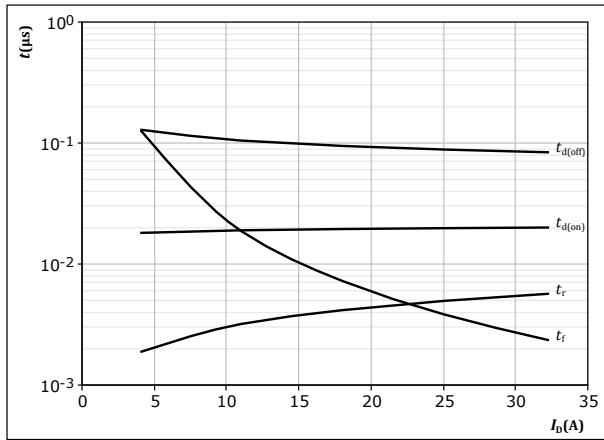


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## PFC Switching Characteristics

**figure 18.**

Typical switching times as a function of drain current  
 $t = f(I_D)$



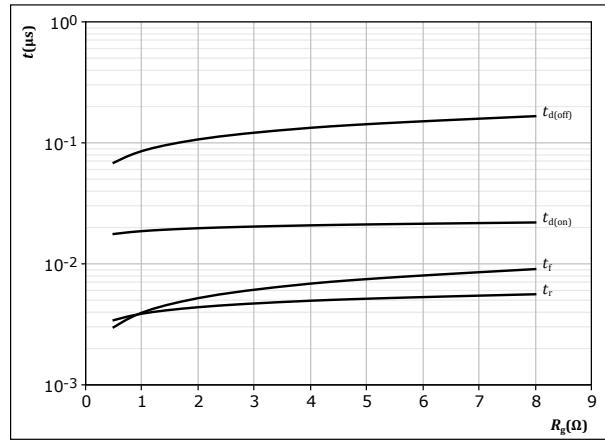
With an inductive load at

$T_j = 125^\circ\text{C}$   
 $V_{DS} = 400 \text{ V}$   
 $V_{GS} = 0/10 \text{ V}$   
 $R_{gon} = 2 \Omega$   
 $R_{goff} = 2 \Omega$

**MOSFET**

**figure 19.**

Typical switching times as a function of gate resistor  
 $t = f(R_g)$



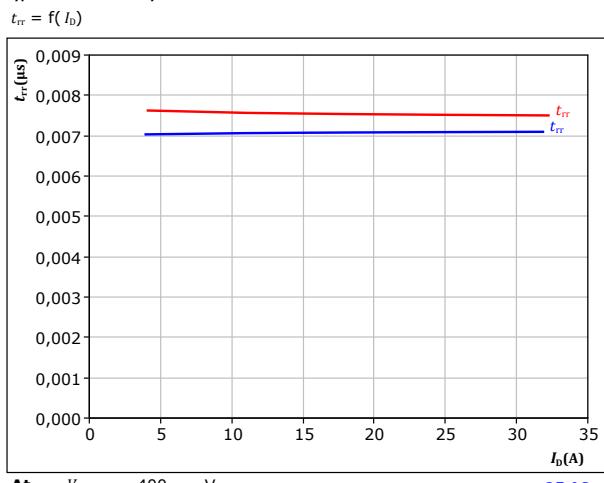
With an inductive load at

$T_j = 125^\circ\text{C}$   
 $V_{DS} = 400 \text{ V}$   
 $V_{GS} = 0/10 \text{ V}$   
 $I_D = 18 \text{ A}$

**MOSFET**

**figure 20.**

Typical reverse recovery time as a function of drain current  
 $t_{rr} = f(I_D)$

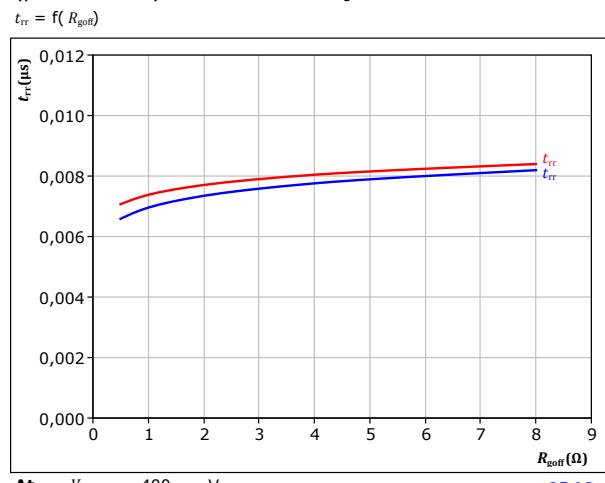


At  $V_{DS} = 400 \text{ V}$   
 $V_{GS} = 0/10 \text{ V}$   
 $R_{gon} = 2 \Omega$

**FWD**

**figure 21.**

Typical reverse recovery time as a function of turn off gate resistor  
 $t_{rr} = f(R_{goff})$



At  $V_{DS} = 400 \text{ V}$   
 $V_{GS} = 0/10 \text{ V}$   
 $I_D = 18 \text{ A}$

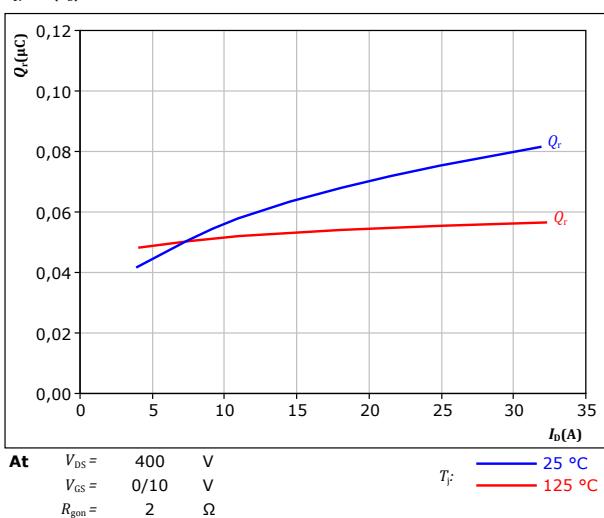


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## PFC Switching Characteristics

figure 22.

Typical recovered charge as a function of drain current  
 $Q_r = f(I_D)$

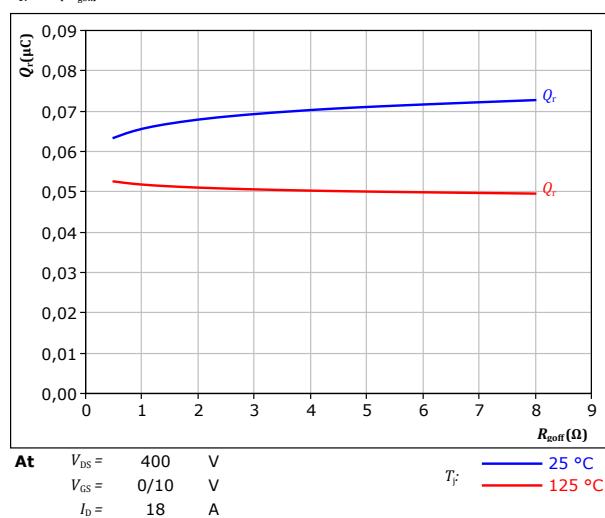


FWD

FWD

figure 23.

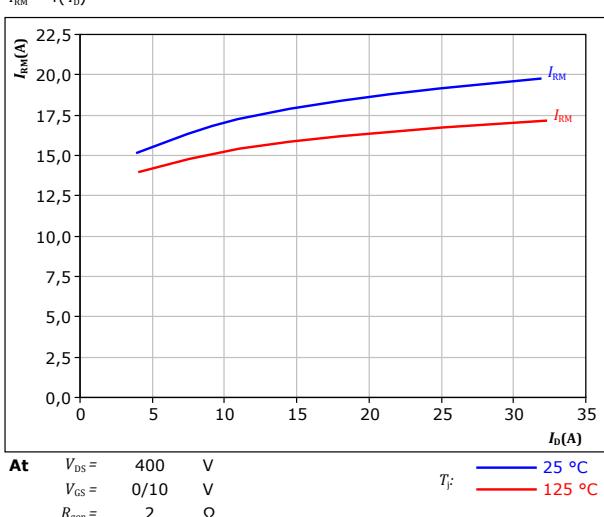
Typical recovered charge as a function of turn off gate resistor  
 $Q_r = f(R_{goff})$



FWD

figure 24.

Typical peak reverse recovery current as a function of drain current  
 $I_{RM} = f(I_D)$

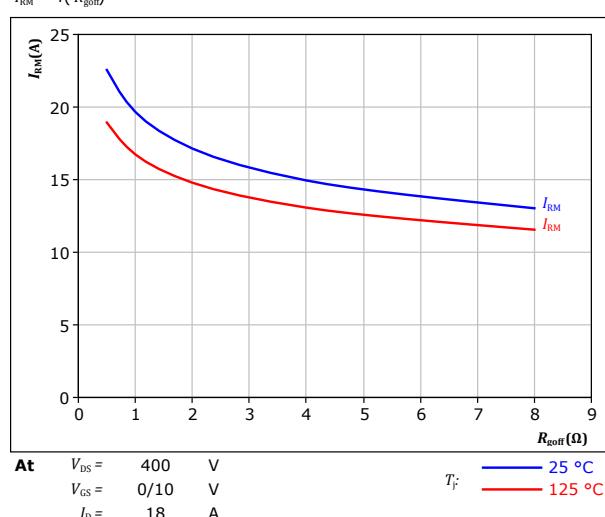


FWD

FWD

figure 25.

Typical peak reverse recovery current as a function of turn off gate resistor  
 $I_{RM} = f(R_{goff})$





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## PFC Switching Characteristics

figure 26. FWD

Typical rate of fall of forward and reverse recovery current as a function of drain current

$$di_f/dt, di_{rr}/dt = f(I_D)$$

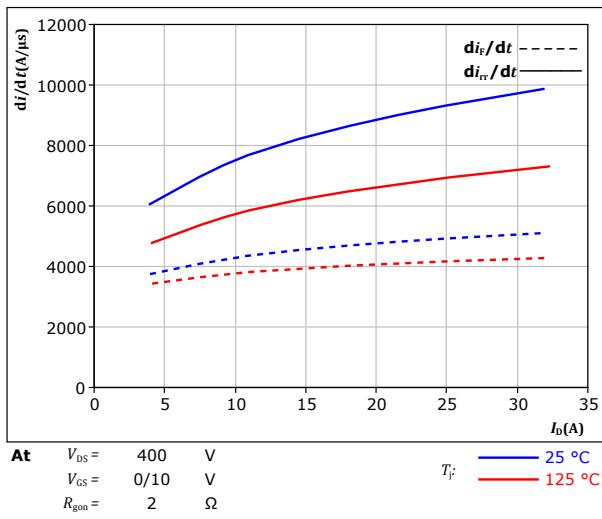


figure 27. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor

$$di_f/dt, di_{rr}/dt = f(R_{goff})$$

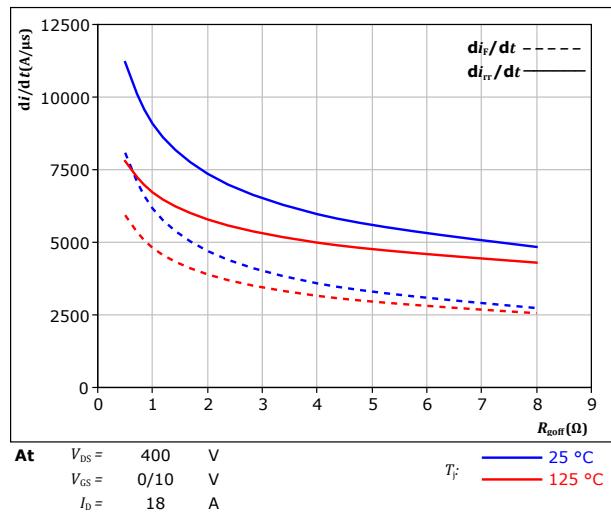
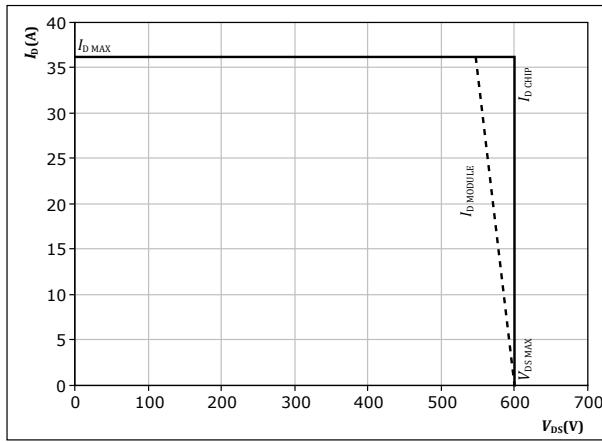


figure 28. MOSFET

Reverse bias safe operating area

$$I_D = f(V_{DS})$$





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## PFC Switching Definitions

figure 29. **MOSFET**

Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )

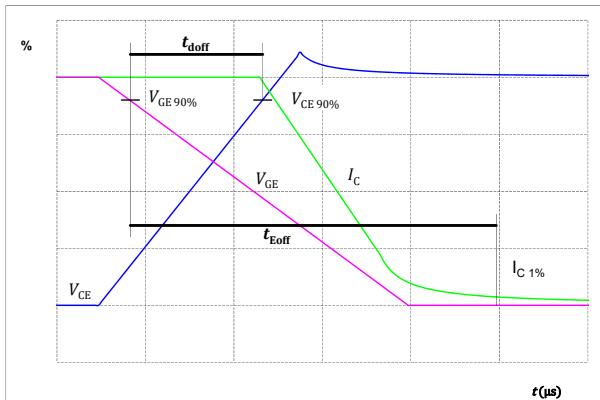


figure 30. **MOSFET**

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )

figure 30. **MOSFET**

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )

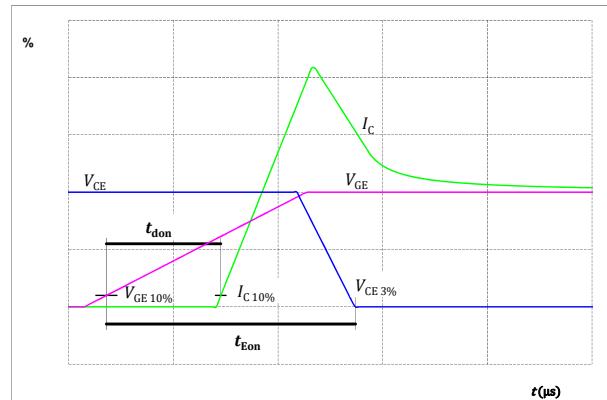


figure 31. **MOSFET**

Turn-off Switching Waveforms & definition of  $t_f$

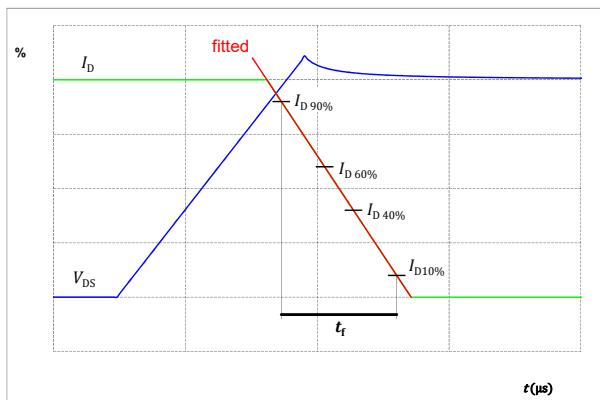
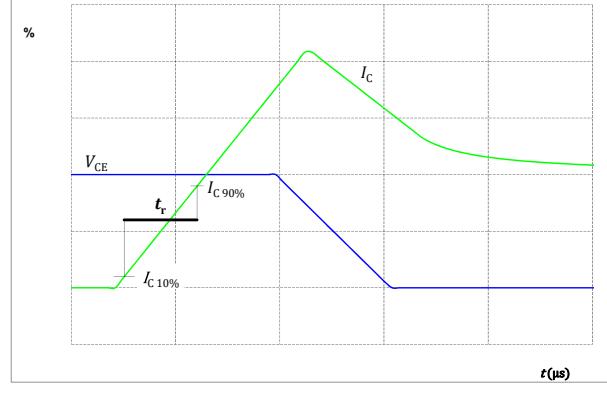


figure 32. **MOSFET**

Turn-on Switching Waveforms & definition of  $t_r$





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## PFC Switching Definitions

figure 33.

Turn-off Switching Waveforms & definition of  $t_{trr}$

FWD

Turn-off Switching Waveforms & definition of  $t_{trr}$

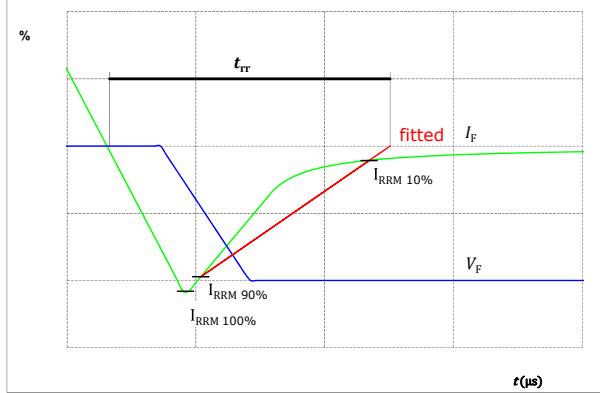


figure 34.

Turn-on Switching Waveforms & definition of  $t_{Qrr}$  ( $t_{Qrr}$  = integrating time for  $Q_{rr}$ )

FWD

Turn-on Switching Waveforms & definition of  $t_{Qrr}$  ( $t_{Qrr}$  = integrating time for  $Q_{rr}$ )

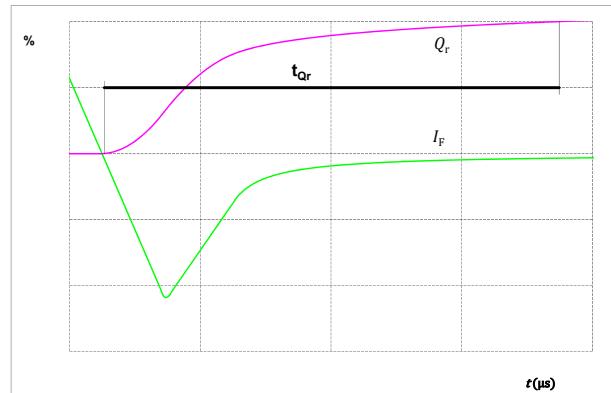
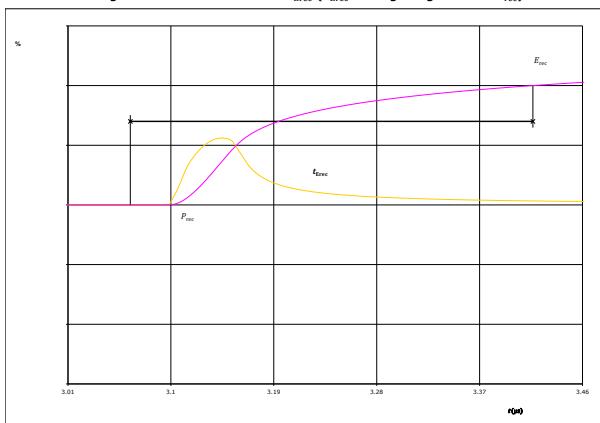


figure 35.

Turn-on Switching Waveforms & definition of  $t_{Erec}$  ( $t_{Erec}$  = integrating time for  $E_{rec}$ )

FWD

Turn-on Switching Waveforms & definition of  $t_{Erec}$  ( $t_{Erec}$  = integrating time for  $E_{rec}$ )





10-FX062TA099FS-P980D57

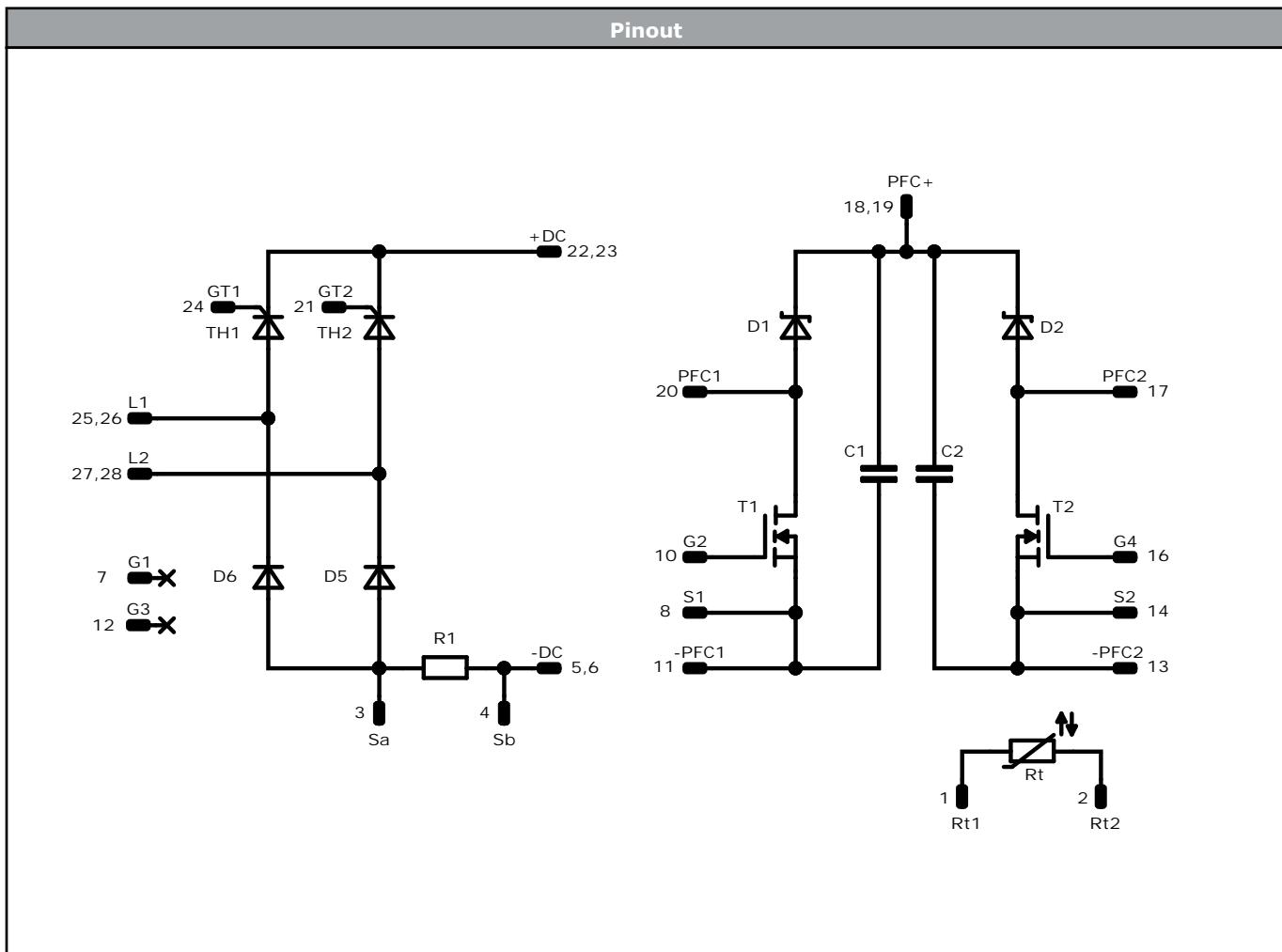
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Ordering Code						
Version			Ordering Code			
Without thermal paste				10-FX062TA099FS-P980D57		
With thermal paste (5,2 W/mK, PTM6000HV)				10-FX062TA099FS-P980D57-/7/		
With thermal paste (3,4 W/mK, PSX-P7)				10-FX062TA099FS-P980D57-/3/		
Marking						
	<b>Text</b>	Name NN-NNNNNNNNNNNNN- TTTTTTVV	Date code WWYY	UL & VIN UL VIN	Lot LLLLL	Serial SSSS
	Datamatrix	Type&Ver TTTTTTVV	Lot number LLLLL	Serial SSSS	Date code WWYY	
Outline						
Pin table [mm]						
Pin	X	Y	Function			
1	33,5	0	Rt1			
2	33,5	2,8	Rt2			
3	29,5	2,8	Sa			
4	29,5	0	Sb			
5	26,7	0	-DC			
6	23,9	0	-DC			
7	21,05	0	G1			
8	14,85	0	S1			
9	not assembled					
10	12,05	0	G2			
11	9,5	12,05	-PFC1			
12	8,2	0	G3			
13	6,7	12,05	-PFC2			
14	3,9	0	S2			
15	not assembled					
16	1,1	0	G4			
17	0	22,7	PFC2			
18	7,1	22,7	+PFC			
19	7,1	20,2	+PFC			
20	14,2	22,7	PFC1			
21	20,7	22,7	GT2			
22	23,5	22,7	+DC			
23	26	22,7	+DC			
24	28,8	22,7	GT1			
25	33,5	18,55	L1			
26	33,5	16,05	L1			
27	33,5	8,7	L2			
28	31	8,7	L2			



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**Identification**

ID	Component	Voltage	Current	Function	Comment
T1, T2	MOSFET	600 V	90 mΩ	PFC Switch	
D1, D2	FWD	600 V	10 A	PFC Diode	
TH1, TH2	Thyristor	1200 V	26 A	Rectifier Thyristor	
D6, D5	Rectifier	1600 V	50 A	Rectifier Diode	
R1	Shunt			PFC Shunt	
C1, C2	Capacitor	500 V		Capacitor (DC)	
Rt	NTC			Thermistor	



10-FX062TA099FS-P980D57

datasheet

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**Packaging instruction**

Standard packaging quantity (SPQ) 135	>SPQ	Standard	<SPQ	Sample
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**Handling instruction**

Handling instructions for flow 0 packages see vincotech.com website.
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**Package data**

Package data for flow 0 packages see vincotech.com website.
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**Vincotech thermistor reference**

See Vincotech thermistor reference table at vincotech.com website.
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**UL recognition and file number**

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.	
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Document No.:	Date:	Modification:	Pages
10-FX062TA099FS-P980D57-D2-14	12 Sep. 2021	New Datasheet format, module is unchanged Correct R/tau values of Rectifier Thyristor and Rectifier Diode thermal characteristics	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.